# Notice for TAIYO YUDEN products

# Please read this notice before using the TAIYO YUDEN products.

# REMINDERS

## Product Information in this Catalog

Product information in this catalog is as of January 2021. All of the contents specified herein and production status of the products listed in this catalog are subject to change without notice due to technical improvement of our products, etc. Therefore, please check for the latest information carefully before practical application or use of our products.

Please note that TAIYO YUDEN shall not be in any way responsible for any damages and defects in products or equipment incorporating our products, which are caused under the conditions other than those specified in this catalog or individual product specification sheets.

### Approval of Product Specifications

Please contact TAIYO YUDEN for further details of product specifications as the individual product specification sheets are available. When using our products, please be sure to approve our product specifications or make a written agreement on the product specification with TAIYO YUDEN in advance.

## Pre-Evaluation in the Actual Equipment and Conditions

Please conduct validation and verification of our products in actual conditions of mounting and operating environment before using our products.

## Limited Application

## 1. Equipment Intended for Use

The products listed in this catalog are intended for generalpurpose and standard use in general electronic equipment (e.g., AV equipment, OA equipment, home electric appliances, office equipment, information and communication equipment including, without limitation, mobile phone, and PC) and other equipment specified in this catalog or the individual product specification sheets.

TAIYO YUDEN has the line-up of the products intended for use in automotive electronic equipment, telecommunications infrastructure and industrial equipment, or medical devices classified as GHTF Classes A to C (Japan Classes I to III). Therefore, when using our products for these equipment, please check available applications specified in this catalog or the individual product specification sheets and use the corresponding products.

## 2. Equipment Requiring Inquiry

Please be sure to contact TAIYO YUDEN for further information before using the products listed in this catalog for the following equipment (excluding intended equipment as specified in this catalog or the individual product specification sheets) which may cause loss of human life, bodily injury, serious property damage and/or serious public impact due to a failure or defect of the products and/or malfunction attributed thereto.

- (1) Transportation equipment (automotive powertrain control system, train control system, and ship control system, etc.)
- (2) Traffic signal equipment
- (3) Disaster prevention equipment, crime prevention equipment
- (4) Medical devices classified as GHTF Class C (Japan Class III)
- (5) Highly public information network equipment, dataprocessing equipment (telephone exchange, and base station, etc.)
- (6) Any other equipment requiring high levels of quality and/or reliability equal to the equipment listed above

### 3. Equipment Prohibited for Use

Please do not incorporate our products into the following equipment requiring extremely high levels of safety and/or reliability.

- (1) Aerospace equipment (artificial satellite, rocket, etc.)
- (2) Aviation equipment \*1
- (3) Medical devices classified as GHTF Class D (Japan Class IV), implantable medical devices \*<sup>2</sup>

- (4) Power generation control equipment (nuclear power, hydroelectric power, thermal power plant control system, etc.)
- (5) Undersea equipment (submarine repeating equipment, underwater work equipment, etc.)
- (6) Military equipment
- Any other equipment requiring extremely high levels of safety and/or reliability equal to the equipment listed above

### \*Notes:

- There is a possibility that our products can be used only for aviation equipment that does not directly affect the safe operation of aircraft (e.g., in-flight entertainment, cabin light, electric seat, cooking equipment) if such use meets requirements specified separately by TAIYO YUDEN. Please be sure to contact TAIYO YUDEN for further information before using our products for such aviation equipment.
- Implantable medical devices contain not only internal unit which is implanted in a body, but also external unit which is connected to the internal unit.

## 4. Limitation of Liability

Please note that unless you obtain prior written consent of TAIYO YUDEN, TAIYO YUDEN shall not be in any way responsible for any damages incurred by you or third parties arising from use of the products listed in this catalog for any equipment that is not intended for use by TAIYO YUDEN, or any equipment requiring inquiry to TAIYO YUDEN or prohibited for use by TAIYO YUDEN as described above.

### Safety Design

When using our products for high safety and/or reliability-required equipment or circuits, please fully perform safety and/or reliability evaluation. In addition, please install (i) systems equipped with a protection circuit and a protection device and/or (ii) systems equipped with a redundant circuit or other system to prevent an unsafe status in the event of a single fault for a failsafe design to ensure safety.

### Intellectual Property Rights

Information contained in this catalog is intended to convey examples of typical performances and/or applications of our products and is not intended to make any warranty with respect to the intellectual property rights or any other related rights of TAIYO YUDEN or any third parties nor grant any license under such rights.

### Limited Warranty

Please note that the scope of warranty for our products is limited to the delivered our products themselves and TAIYO YUDEN shall not be in any way responsible for any damages resulting from a failure or defect in our products. Notwithstanding the foregoing, if there is a written agreement (e.g., supply and purchase agreement, quality assurance agreement) signed by TAIYO YUDEN and your company, TAIYO YUDEN will warrant our products in accordance with such agreement.

## TAIYO YUDEN's Official Sales Channel

The contents of this catalog are applicable to our products which are purchased from our sales offices or authorized distributors (hereinafter "TAIYO YUDEN's official sales channel"). Please note that the contents of this catalog are not applicable to our products purchased from any seller other than TAIYO YUDEN's official sales channel.

### Caution for Export

Some of our products listed in this catalog may require specific procedures for export according to "U.S. Export Administration Regulations", "Foreign Exchange and Foreign Trade Control Law" of Japan, and other applicable regulations. Should you have any questions on this matter, please contact our sales staff.

# Automotive Application Guide

We classify automotive electronic equipment into the following four application categories and set usable application categories for each of our products. When using our products for automotive electronic equipment, please be sure to check such application categories and use our products accordingly. Should you have any questions on this matter, please contact us.

Category	Automotive Electronic Equipment (Typical Example)
POWERTRAIN	<ul> <li>Engine ECU (Electronically Controlled Fuel Injector)</li> <li>Cruise Control Unit</li> <li>4WS (4 Wheel Steering)</li> <li>Transmission</li> <li>Power Steering</li> <li>HEV/PHV/EV Core Control (Battery, Inverter, DC-DC)</li> <li>Automotive Locator (Car location information providing device), etc.</li> </ul>
SAFETY	<ul> <li>ABS (Anti-Lock Brake System)</li> <li>ESC (Electronic Stability Control)</li> <li>Airbag</li> <li>ADAS (Equipment that directly controls running, turning and stopping), etc.</li> </ul>
BODY & CHASSIS	<ul> <li>Wiper</li> <li>Automatic Door</li> <li>Power Window</li> <li>Keyless Entry System</li> <li>Electric Door Mirror</li> <li>Automobile Digital Mirror</li> <li>Interior Lighting</li> <li>Automobile Air Conditioning System</li> <li>LED Headlight</li> <li>TPMS (Tire Pressure Monitoring System)</li> <li>Anti-Theft Device (Immobilizer), etc.</li> </ul>
INFOTAINMENT	<ul> <li>Car Infotainment System</li> <li>ITS/Telematics System</li> <li>Instrument Cluster</li> <li>ADAS (Sensor, Equipment that is not interlocked with safety equipment or powertrain)</li> <li>Dashcam (genuine products for automotive manufacturer), etc.</li> </ul>

# for High Quality Equipment

# METAL CORE SMD POWER INDUCTORS (MCOIL<sup>™</sup> MD SERIES)

AEC-Q200 Grade 3 (we conduct the evaluation at the test condition of Grade 3.) \*Operating environment Temp:-40~85°C



PART NUMBER \*0 D М 2 0 R 0 М Μ V Μ Κ 2 0 Т 1 Δ Δ  $\triangle = Blank space$ 3 (5) 1 2 4 6  $\overline{\mathcal{O}}$ (8) (9)

①Series name

Code	Series name
MD	Metal base coil specification

(Dimensions (H)

Code	Dimensions(H)[mm]
KK	1.0
MK	1.2
WK	2.0

③Dimensions(L × W)

Code	Dimensions $(L \times W)$ [mm]
2020	2.0×2.0
3030	3.0 × 3.0
4040	4.0 × 4.0

④Packaging		
Code	Packaging	
Т	Taping	

*Operating Temp. :	$-40 \sim 125^{\circ}C$ (Including self-generated heat)

5 Nominal inductance

Code (example)	Nominal inductance [ $\mu$ H]
R47	0.47
1R0	1.0
4R7	4.7
	-

※R=Decimal point

6 Inductance tolerance

Code	Inductance tolerance
М	±20%
N	±30%

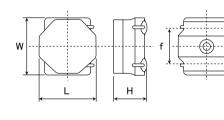
⑦Special code 1	
Code	Special code
F	Ferrite coating
М	Metal coating

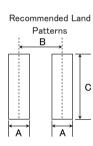
(8)Special code 2	
Code	

$\Delta\Delta$	Standard

Code	Internal code
V	Inductor for Automotive
8	Inductor for Telecommunications infrastructure and Industrial equipment / Medical devices

# STANDARD EXTERNAL DIMENSIONS





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Туре	A	В	С
MDKK2020	0.65	1.35	20
MDMK2020	0.05	1.30	2.0
MDKK3030	0.8	2.2	27
MDMK3030	0.8	2.2	2.7
MDMK4040/ MDWK4040	1.2	2.8	3.7
			Unit:m

Special code

Туре	L	W	н	е	f	Standard quantity [pcs] Taping
MDKK2020	$2.0 \pm 0.15$ (0.079 $\pm 0.006$ )	2.0±0.15 (0.079±0.006)	1.0 max (0.039 max)	$0.50 \pm 0.2$ (0.02 \pm 0.008)	$1.25 \pm 0.2$ (0.049 ± 0.008)	2500
MDMK2020	$2.0 \pm 0.15$ (0.079 $\pm 0.006$ )	2.0±0.15 (0.079±0.006)	1.2 max (0.047 max)	$0.50 \pm 0.2$ (0.02 $\pm 0.008$ )	$1.25 \pm 0.2$ (0.049 ± 0.008)	2500
MDKK3030	3.0±0.1 (0.118±0.004)	3.0±0.1 (0.118±0.004)	1.0 max (0.039 max)	0.90±0.2 (0.035±0.008)	1.9±0.2 (0.075±0.008)	2000
MDMK3030	$3.0 \pm 0.1$ (0.118 $\pm$ 0.004)	3.0±0.1 (0.118±0.004)	1.2 max (0.047 max)	0.90±0.2 (0.035±0.008)	1.9±0.2 (0.075±0.008)	2000
MDMK4040	4.0±0.2 (0.157±0.008)	4.0±0.2 (0.157±0.008)	1.2 max (0.047 max)	$1.1 \pm 0.2$ (0.043 ± 0.008)	2.5±0.2 (0.098±0.008)	1000
MDWK4040	4.0±0.2 (0.157±0.008)	4.0±0.2 (0.157±0.008)	2.0 max (0.079 max)	1.1±0.2 (0.043±0.008)	2.5±0.2 (0.098±0.008)	700

Unit:mm(inch)

# PART NUMBER

· All the Metal Core SMD Power Inductors of the catalog lineup are RoHS compliant.

### Notes)

- The exchange of individual specifications is necessary depending on your application and/or circuit condition. Please contact TAIYO YUDEN's official sales channel.
- . For Automotive (AEC-Q200 Qualified) products for BODY & CHASSIS, and INFOTAINMENT. Please check "Automotive Application Guide" for further details before using the products. < AEC-Q200 :AEC-Q200 qualified>
  - All the Metal Core SMD Power Inductors for Automotive products are tested based on the test conditions and methods defined in AEC-Q200 by family item.
  - Please consult with TAIYO YUDEN's official sales channel for the details of the product specifications and AEC-Q200 test results, etc.,

and please review and approve the product specifications before ordering.

MDKK2020 type	【Thickness: 1.0mm max】			<b>D</b>		1	
Part number	Nominal inductance [	Inductance tolerance	DC Resistance [Ω](max.)	Rated curren Saturation current Idc1 Max (Typ)	t ※) [mA] Temperature rise current Idc2 Max (Typ)	Measuring frequency[MHz]	Note
MDKK2020TR47MM V	0.47	±20%	0.046	3,500 (4,150)	2,200 (2,500)	1	
MDKK2020TR68MM V	0.68	±20%	0.060	3,200 (3,650)	2,000 (2,100)	1	
MDKK2020T1R0MM V	1	±20%	0.085	2,900 (3,400)	1,700 (1,900)	1	
MDKK2020T1R5MM V	1.5	±20%	0.133	1,900 (2,250)	1,350 (1,500)	1	
MDKK2020T2R2MM V	2.2	±20%	0.165	1,650 (1,950)	1,200 (1,350)	1	
MDKK2020T3R3MM V	3.3	±20%	0.275	1,300 (1,550)	940 (1,050)	1	
MDKK2020T4R7MM V	4.7	±20%	0.435	1,050 (1,250)	750 (850)	1	
MDKK2020T100MM V	10	±20%	0.690	750 (900)	630 (680)	1	

Absolute maximum voltage: DC20V

(Tvp): Reference

#### MDMK2020 type [Thickness: 1.2mm max]

				Rated curren			
Part number	Nominal inductance [μΗ]	Inductance tolerance	DC Resistance [Ω](max.)	Saturation current Idc1	Temperature rise current Idc2	Measuring frequency[MHz]	Note
				Max (Typ)	Max (Typ)		
MDMK2020TR47MM V	0.47	±20%	0.046	4,200 (4,800)	2,300 (2,450)	1	
MDMK2020TR68MM V	0.68	±20%	0.058	3,500 (4,100)	2,000 (2,200)	1	
MDMK2020T1R0MM V	1	±20%	0.064	2,550 (2,900)	1,900 (2,050)	1	
MDMK2020T1R5MM V	1.5	±20%	0.086	2,000 (2,300)	1,650 (1,750)	1	
MDMK2020T2R2MM V	2.2	±20%	0.109	1,750 (2,000)	1,450 (1,550)	1	
MDMK2020T3R3MM V	3.3	±20%	0.178	1,350 (1,550)	1,150 (1,200)	1	
MDMK2020T4R7MM V	4.7	±20%	0.242	1,150 (1,300)	950 (1,050)	1	
Absolute maximum voltas	ge: DC20V					(Tvn	): Reference

#### MDKK3030 type 【Thickness:1.0mm max】

				Rated curren	ıt 涨)[mA]		
Part number	Nominal inductance [ µ H]	Inductance tolerance	DC Resistance [Ω](max.)	Saturation current Idc1 Max (Typ)	Temperature rise current Idc2 Max (Typ)	Measuring frequency[MHz]	Note
MDKK3030TR47MM V	0.47	±20%	0.039	5,400 (6,500)	3,900 (4,500)	1	
MDKK3030T1R0MM V	1.0	±20%	0.086	4,400 (5,200)	2,400 (2,800)	1	
MDKK3030T1R5MM V	1.5	±20%	0.100	3,000 (3,500)	2,100 (2,400)	1	
MDKK3030T2R2MM V	2.2	±20%	0.144	2,500 (3,000)	1,900 (2,200)	1	
MDKK3030T3R3MM V	3.3	±20%	0.248	2,000 (2,400)	1,350 (1,500)	1	
MDKK3030T4R7MM V	4.7	±20%	0.345	1,700 (2,000)	1,150 (1,300)	1	
MDKK3030T6R8MM V	6.8	±20%	0.437	1,400 (1,700)	1,000 (1,150)	1	
MDKK3030T100MM V	10	±20%	0.575	1,100 (1,300)	850 (1,000)	1	
Absolute maximum volta	ge:DC20V					(Тур	):Reference

Absolute maximum voltage: DC20V

### MDMK3030 type [Thickness:1.2mm max]

				Rated curren	t ※)[mA]		1
Part number	Nominal inductance [	Inductance tolerance	DC Resistance [Ω](max.)	Saturation current Idc1 Max (Typ)	Temperature rise current Idc2 Max (Typ)	Measuring frequency[MHz]	Note
MDMK3030TR30MM V	0.30	±20%	0.020	7,600 (9,200)	5,500 (6,400)	1	
MDMK3030TR33MM V	0.33	±20%	0.020	6,400 (8,700)	5,500 (6,400)	1	
MDMK3030TR47MM V	0.47	±20%	0.027	6,300 (7,500)	4,700 (5,500)	1	
MDMK3030T1R0MM V	1.0	±20%	0.050	4,300 (5,100)	3,300 (3,900)	1	
MDMK3030T1R5MM V	1.5	±20%	0.074	3,400 (4,100)	2,500 (3,000)	1	
MDMK3030T2R2MM V	2.2	±20%	0.112	2,800 (3,600)	2,100 (2,400)	1	
MDMK3030T3R3MM V	3.3	±20%	0.173	2,100 (2,700)	1,650 (1,900)	1	
MDMK3030T4R7MM V	4.7	±20%	0.263	1,800 (2,300)	1,350 (1,550)	1	
Absolute maximum voltag	ge:DC20V					(Тур	):Reference

Absolute maximum voltage: DC20V

\*) The saturation current value (Idc1) is the DC current value having inductance decrease down to 30%. (at 20°C)

1-1) The temperature rise current value (Idc2) is the DC current value having temperature increase by 40°C, when mounted in FR4 High heat dissipation board (board thickness: 1.0mm copper thickness : 0.035mm, board size : 110 × 30 × 1.0mm, land size : 12.6 × 19.6mm). (at 20°C)

💥 1-2) The temperature rise current value (Idc2) is the DC current value having temperature increase by 40°C, when mounted in FR4 High heat dissipation board (board thickness: 1.6mm copper thickness:0.050mm, board size:100 × 100 × 1.6mm, land size:14.6 × 43mm). (at 20°C)

1-3) The temperature rise current value (Idc2) is the DC current value having temperature increase by 40°C, when mounted in FR4 High heat dissipation board (board thickness: 1.6mm copper thickness: 0.050mm, board size:  $100 \times 100 \times 1.6$ mm, land size:  $44.5 \times 90$ mm). (at  $20^{\circ}$ C)

\*) The rated current is the DC current value that satisfies both of current value saturation current value and temperature rise current value.

%1-1) MDKK2020, MDMK2020 type

※1-2) MDKK3030, MDMK3030 type

※1-3) MDMK4040, MDWK4040 type

> This catalog contains the typical specification only due to the limitation of space. When you consider the purchase of our products, please check our product specification sheets. For details of each product (characteristics graph, reliability information, precautions for use, and so on), see our website (http://www.ty-top.com/)

AUTO

For Automotive Electronic Equipment METAL CORE SMD POWER INDUCTORS (MCOIL<sup>TM</sup> MD SERIES)

# for High Quality Equipment

### PART NUMBER

MDMK4040F type	[Thickness: 1.2mm max]	1						
				Rated curren	t ※)[mA]			
Part number	Nominal inductance	Inductance tolerance	DC Resistance	Saturation current	Temperature rise current	Measuring	Note	
i are nambor	[μH]		[Ω](max.)	Idc1	Idc2	frequency[kHz]		
				Max (Typ)	Max (Typ)			
MDMK4040TR47MF V	0.47	±20%	0.029	7,500 (10,000)	4,600 (5,400)	100		
MDMK4040T1R0MF V	1.0	±20%	0.047	5,200 (7,500)	3,500 (4,200)	100		
MDMK4040T1R2MF V	1.2	±20%	0.047	4,200 (6,200)	3,500 (4,200)	100		
MDMK4040T1R5MF V	1.5	±20%	0.065	3,700 (5,400)	3,300 (3,600)	100		
MDMK4040T2R2MF V	2.2	±20%	0.092	3,200 (4,500)	2,500 (2,900)	100		
Absolute maximum voltag	ge:DC25V					(Тур	):Reference	

(Typ): Reference

#### MDMK4040 type [Thickness: 1.2mm max]

				Rated curren			
Part number	Nominal inductance [μH]	Inductance tolerance	DC Resistance [Ω](max.)	Saturation current Idc1	Temperature rise current Idc2	Measuring frequency[MHz]	Note
	C/2 · · · 3		2 3 (	Max (Typ)	Max (Typ)		
MDMK4040TR68MM V	0.68	±20%	0.029	6,700 (7,800)	5,000 (5,700)	1	
MDMK4040T1R0MM V	1.0	±20%	0.036	5,000 (6,200)	4,500 (5,100)	1	
MDMK4040T1R5MM V	1.5	±20%	0.065	4,500 (5,600)	3,200 (3,600)	1	
MDMK4040T2R2MM V	2.2	±20%	0.079	3,800 (4,500)	2,800 (3,200)	1	
MDMK4040T3R3MM V	3.3	±20%	0.130	3,200 (4,000)	2,200 (2,500)	1	
MDMK4040T4R7MM V	4.7	±20%	0.160	2,500 (3,000)	1,900 (2,200)	1	
MDMK4040T6R8MM V	6.8	±20%	0.230	1,900 (2,200)	1,600 (1,800)	1	
MDMK4040T100MM V	10	±20%	0.330	1700 (2,000)	1,400 (1,600)	1	

Absolute maximum voltage: DC25V

### MDWK4040 type

MDWK4040 type	[Thickness: 2.0mm max]	1					
				Rated curren			
Part number	Nominal inductance	Inductance tolerance	DC Resistance [Ω](max.)	Saturation current	Temperature rise current	Measuring	Note
	[ µ H]		[ 52 ] (max.)	Idc1 Max (Tvp)	Idc2 Max (Typ)	frequency[MHz]	
MDWK4040TR56NM V	0.56	±20%	0.016	9,000 (13,000)	6,500 (7,500)	1	
MDWK4040TR68MM V	0.68	±20%	0.016	8,000 (12,000)	7,300 (8,300)	1	
MDWK4040T1R0MM V	1.0	±20%	0.027	7,000 (9,400)	5,100 (5,800)	1	
MDWK4040T1R5MM V	1.5	±20%	0.041	7,000 (9,400)	4,100 (4,700)	1	
MDWK4040T2R2MM V	2.2	±20%	0.054	5,400 (7,500)	3,500 (4,000)	1	
MDWK4040T3R3MM V	3.3	±20%	0.075	3,700 (5,200)	3,000 (3,300)	1	
MDWK4040T4R7MM V	4.7	±20%	0.107	3,500 (5,000)	2,500 (2,800)	1	
MDWK4040T6R8MM V	6.8	±20%	0.158	2,900 (4,000)	2,000 (2,300)	1	
MDWK4040T100MM V	10	±20%	0.194	2,200 (3,100)	1,600 (1,900)	1	
Absolute maximum voltag	ge:DC25V					(Тур	:Reference

\*) The saturation current value (Idc1) is the DC current value having inductance decrease down to 30%. (at 20°C)

copper thickness:0.035mm, board size:110 × 30 × 1.0mm, land size:12.6 × 19.6mm). (at 20°C)

💥 1-2) The temperature rise current value (Idc2) is the DC current value having temperature increase by 40°C, when mounted in FR4 High heat dissipation board (board thickness: 1.6mm copper thickness: 0.050mm, board size:  $100 \times 100 \times 1.6$ mm, land size:  $14.6 \times 43$ mm). (at  $20^{\circ}$ C)

💥 1-3) The temperature rise current value (Idc2) is the DC current value having temperature increase by 40°C, when mounted in FR4 High heat dissipation board (board thickness: 1.6mm copper thickness: 0.050mm, board size: 100 × 100 × 1.6mm, land size: 44.5 × 90mm). (at 20°C)

\*) The rated current is the DC current value that satisfies both of current value saturation current value and temperature rise current value.

%1-1) MDKK2020, MDMK2020 type

\*1-2) MDKK3030, MDMK3030 type

※1-3) MDMK4040, MDWK4040 type

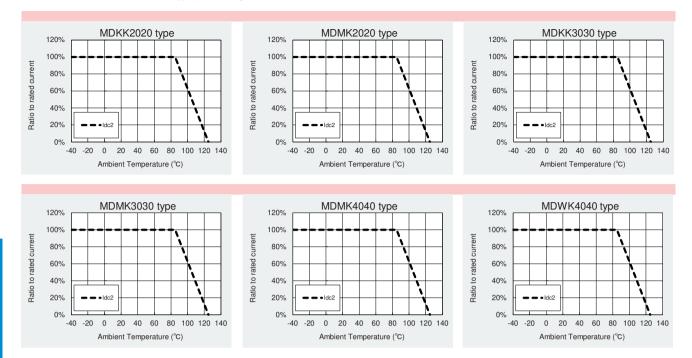
INDUCTORS

# for High Quality Equipment

## Derating of Rated Current

### MD series

Derating of current is necessary for MD series depending on ambient temperature. Please refer to the chart shown below for appropriate derating of current.



RS S

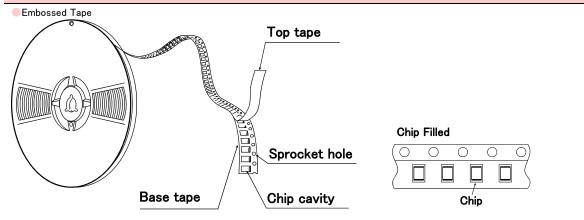
**AUTO** 

# METAL CORE SMD POWER INDUCTORS (MCOIL<sup>™</sup> MD SERIES)

# PACKAGING

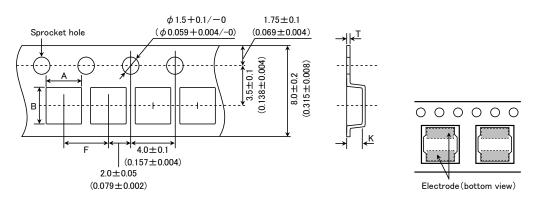
①Minimum Quantity	
Туре	Standard Quantity [pcs]
туре	Tape & Reel
MDKK1616	2500
MDJE2020	
MDKK2020	2500
MDMK2020	
MDKK3030	2000
MDMK3030	2000
MDJE4040	1000
MDMK4040	1000
MDWK4040	700
MDPK5050	1000

# (2) Tape Material



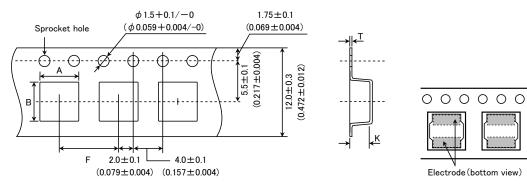
## $\textcircled{3}\mathsf{Taping dimensions}$

Embossed tape 8mm wide (0.315 inches wide)



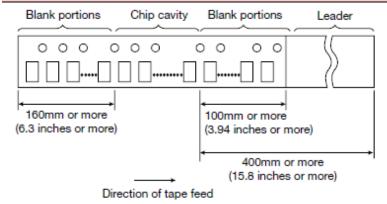
Туре	Chip	cavity	Insertion pitch	Tape thickness		
	A	В	F	Т	К	
MDKK1616	$1.79 \pm 0.1$ (0.071 ± 0.004)	1.79±0.1 (0.071±0.004)	$4.0 \pm 0.1$ (0.157 $\pm 0.004$ )	$0.25 \pm 0.05$ (0.010 $\pm 0.002$ )	$1.1 \pm 0.1$ (0.043 ± 0.004)	
MDJE2020 MDKK2020 MDMK2020	$2.2 \pm 0.1$ (0.102 $\pm 0.004$ )	$2.2 \pm 0.1$ (0.102 \pm 0.004)	4.0±0.1 (0.157±0.004)	$0.25 \pm 0.05$ (0.009 $\pm 0.002$ )	1.3±0.1 (0.051±0.004)	
MDKK3030 MDMK3030	$3.2 \pm 0.1$ (0.126 $\pm 0.004$ )	$3.2 \pm 0.1$ (0.126 ± 0.004)	4.0±0.1 (0.157±0.004)	0.3±0.05 (0.012±0.002)	1.4±0.1 (0.055±0.004)	
					Unit:mm(inch)	

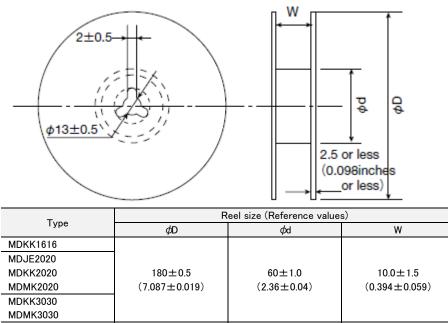
## Embossed tape 12mm wide (0.47 inches wide)



Туре	Chip cavity		Insertion pitch	Tape thickness	
туре	А	В	F	Т	К
MDJE4040	4.3±0.1	4.3±0.1	8.0±0.1	$0.3 \pm 0.05$	1.6±0.1
MDMK4040	$(0.169 \pm 0.004)$	$(0.169 \pm 0.004)$	$(0.315 \pm 0.004)$	$(0.012 \pm 0.002)$	$(0.063 \pm 0.004)$
MDWK4040	4.3±0.1	4.3±0.1	8.0±0.1	$0.3 \pm 0.05$	2.3±0.1
	$(0.169 \pm 0.004)$	$(0.169 \pm 0.004)$	$(0.315 \pm 0.004)$	$(0.012 \pm 0.002)$	$(0.091 \pm 0.004)$
	$5.25 \pm 0.1$	$5.25 \pm 0.1$	8.0±0.1	0.3±0.1	1.6±0.1
MDPK5050	(0.207±0.004)	$(0.207 \pm 0.004)$	$(0.315 \pm 0.004)$	$(0.012 \pm 0.004)$	$(0.063 \pm 0.004)$
	•		•		Unit:mm(inch)

# 4Leader and Blank portion





 MDJE4040
 180±3.0
 60±2.0
 14.0±1.5

 MDWK4040
 (7.087±0.118)
 (2.36±0.08)
 (0.551±0.059)

 MDPK5050
 Unit:mm(inch)

# 6 Top Tape Strength

Top tape strength		
Туре	Peel-off strength	
MDKK1616		
MDJE2020		
MDKK2020	0.1N~1.0N	$165^{\circ} \sim 180^{\circ}$ Pull direction
MDMK2020	0.111~1.011	Top tape
MDKK3030		
MDMK3030		
MDJE4040		
MDMK4040	0.111-1.1.211	Base tape
MDWK4040	0.1N~1.3N	
MDPK5050		



# METAL CORE SMD POWER INDUCTORS (MCOIL<sup>™</sup> MD SERIES)

RELIABILITY DATA

Specified Value

MD series

1. Operating Temperature Range		
Specified Value	MD series	$-40 \sim +125^{\circ} C ($ Including self-generated heat $)$
Test Methods and Remarks	Including self-generated heat	

2. Storage Temperature Range		
Specified Value	MD series	$-40 \sim +85^{\circ}C$
Test Methods and Remarks	-5 to 40°C for the product with taping.	

3. Rated current		
Specified Value	MD series	Within the specified tolerance
	•	·

4. Inductance				
Specified Value	MD series	Within the specified tolerance		
	MDKK2020, MDMK2020, MD	MDKK2020、MDMK2020、MDKK3030、MDMK3030、MDMK4040M、MDWK4040		
	Measuring equipment	: LCR Meter(HP 4285A or equivalent)		
Test Methods and Remarks	Measuring frequency	: 1MHz 1V		
	MDMK4040F			
	Measuring equipment	: LCR Meter(HP 4285A or equivalent)		
	Measuring frequency	: 100kHz 1V		

5. DC Resistance			
Specified Value	MD series		Within the specified tolerance
Test Methods and Remarks	Measuring equipment	: DC ohmmeter(HI	IIOKI 3227 or equivalent)

6. Self resonance fr	requency	
Specified Value	MD series	-

7. Temperature characteristic		
Specified Value	MD series Inductance change : Within ±10%	
Test Methods and Remarks	Measurement of inductance shall be taken at temperature range within $-40^{\circ}C \sim +125^{\circ}C$ . With reference to inductance value at $+20^{\circ}C$ ., change rate shall be calculated.	

8. Resistance to fle	8. Resistance to flexure of substrate			
Specified Value	MD series		No damage	
Test Methods and Remarks	The test samples shall be s until deflection of the test Test board size Test board material Solder cream thickness		Force Rod 10/20	

9. Insulation resistance : between wires			
Specified Value MD series -			
10. Insulation resistance : between wire and core			

This catalog contains the typical specification only due to the limitation of space. When you consider the purchase of our products, please check our specification. For details of each product (characteristics graph, reliability information, precautions for use, and so on), see our Web site (http://www.ty-top.com/).

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11. Withstanding voltage : between wire and core			
Specified Value	MD series	-	

12. Adhesion of terminal electrode			
Specified Value	MD series		Shall not come off PC board
	The test samples shall be soldered to the test board by the reflow.		
Test Methods and	Applied force : 10N to X and		Y directions.
Remarks	Duration	: 5s.	
	Solder cream thickness	: 0.1mm.	

#### 13. Resistance to vibration Inductance change : Within $\pm 10\%$ Specified Value MD series No significant abnormality in appearance. The test samples shall be soldered to the test board by the reflow. Then it shall be submitted to below test conditions. Frequency Range 10~55Hz Total Amplitude 1.5mm (May not exceed acceleration $196 \text{m/s}^2$ ) Test Methods and Sweeping Method 10Hz to 55Hz to 10Hz for 1min. Remarks Х Time Υ For 2 hours on each X, Y, and Z axis. Ζ Recovery : At least 2hrs of recovery under the standard condition after the test, followed by the measurement within 48hrs.

14. Solderability			
Specified Value	MD series		At least 90% of surface of terminal electrode is covered by new solder.
Test Methods and Remarks	The test samples shall be dip Flux : Methanol solution conta Solder Temperature Time XImmersion depth : All sides	aining rosin 25%. 245±5°C 5±1.0 sec.	hen immersed in molten solder as shown in below table.

15. Resistance to se	15. Resistance to soldering heat			
Specified Value	MD series	Inductance change : Within $\pm 10\%$ No significant abnormality in appearance.		
Test Methods and Remarks	The test sample shall be exposed to reflow oven at $230\pm5^{\circ}$ C for 40 seconds, with peak temperature at $260\pm5^{\circ}$ C for 5 seconds, 2 times Test board material : glass epoxy-resin Test board thickness : 1.0mm			

16. Thermal shock					
Specified Value	MD series			Inductance change : N No significant abnorm	
		step 1 to step 4 as shown in b	oelow ta	-	he test samples shall be placed at specified temperature for specified emperature cycle shall be repeated 1000 cycles.
	Conditions of 1 cycle Step Temperature (°C)				
Test Methods and				Duration (min)	
Remarks	narks 1 -40±3			30±3	
	2	Room temperature		Within 3	
	3	$+85\pm2$		30±3	
	4	Room temperature		Within 3	

17. Damp heat			
Specified Value	MD series		Inductance change : Within $\pm 10\%$ No significant abnormality in appearance.
Test Methods and			
Remarks			
	Humidity	90~95%RH	
	Time	1000+24/-0 hour	



18. Loading under d	amp heat		
Specified Value	MD series		Inductance change : Within $\pm 10\%$ No significant abnormality in appearance.
Test Methods and			t board by the reflow. ostatic oven set at specified temperature and humidity and applied the rated current
Remarks	Temperature Humidity	60±2°C 90~95%RH	
	Applied current	Rated current	
	Time	1000 + 24/-0 hour	

19. Low temperature	e life test		
Specified Value	MD series		Inductance change : Within $\pm 10\%$ No significant abnormality in appearance.
Test Methods and	The test samples shall be soldered to the test in below table.		board by the reflow. After that, the test samples shall be placed at test conditions as shown
Remarks	Temperature	-40±2°C	
	Time	1000+24/-0 hour	

20. High temperatur	re life test	
Specified Value	MD series	-

21. Loading at high	oading at high temperature life test			
Specified Value	MD series		Inductance change : Within $\pm$ 10% No significant abnormality in appearance.	
Test Methods and	The test samples shall be soldered to the test board by the reflow. The test samples shall be placed in thermostatic oven set at specified temperature and applied the rated current continuously as shown in below table.			
Remarks	Temperature	85±2°C		
	Applied current	Rated current		
	Time	1000+24/-0 hour		

22. Standard condition		
Specified Value	MD series	Standard test condition : Unless otherwise specified, temperature is $20\pm15^{\circ}$ C and $65\pm20\%$ of relative humidity. When there is any question concerning measurement result: In order to provide correlation data, the test shall be condition of $20\pm2^{\circ}$ C of temperature, $65\pm5\%$ relative humidity. Inductance is in accordance with our measured value.

# PRECAUTIONS

1. Circuit Design	
Precautions	<ul> <li>Operating environment</li> <li>The products listed in this catalogue are intended for use in general electronic equipment (e.g., AV equipment, OA equipment, home electric appliances, office equipment, information and communication equipment), general medical equipment, industrial equipment, and automotive interior applications, etc.</li> <li>Please be sure to contact TAIYO YUDEN for further information before using the products for any equipment which may directly cause loss of human life or bodily injury (e.g., specially controlled medical equipment, transportation equipment including, without limitation, automotive powertrain control system, train control system, and ship control system, traffic signal equipment).</li> <li>Please do not incorporate our products into any equipment requiring high levels of safety and/or reliability (e.g., aerospace equipment, aviation equipment, nuclear control equipment, undersea equipment, military equipment, etc.).</li> </ul>

2. PCB Design	
Precautions	<ul> <li>◆Land pattern design</li> <li>1. Please refer to a recommended land pattern.</li> </ul>
Technical considerations	<ul> <li>Land pattern design</li> <li>Surface Mounting</li> <li>Mounting and soldering conditions should be checked beforehand.</li> <li>Applicable soldering process to this products is reflow soldering only.</li> </ul>

3. Considerations for automatic placement	
Precautions	<ul> <li>Adjustment of mounting machine</li> <li>1. Excessive impact load should not be imposed on the products when mounting onto the PC boards.</li> <li>2. Mounting and soldering conditions should be checked beforehand.</li> </ul>
Technical considerations	<ul> <li>Adjustment of mounting machine</li> <li>1. When installing products, care should be taken not to apply distortion stress as it may deform the products.</li> </ul>

4. Soldering	
Precautions	<ul> <li>Reflow soldering <ol> <li>Please contact any of our offices for a reflow soldering, and refer to the recommended condition specified.</li> <li>The product shall be used reflow soldering only.</li> <li>Please do not add any stress to a product until it returns in normal temperature after reflow soldering.</li> <li>Lead free soldering <ol> <li>When using products with lead free soldering, we request to use them after confirming adhesion, temperature of resistance to soldering heat, soldering etc sufficiently.</li> </ol> </li> <li>Recommended conditions for using a soldering iron (NR10050 Type) <ol> <li>Put the soldering iron on the land-pattern.</li> <li>Soldering iron's temperature - Below 350°C</li> <li>Duration - 3 seconds or less</li> <li>The soldering iron should not directly touch the inductor.</li> </ol> </li> </ol></li></ul>
Technical considerations	<ul> <li>Reflow soldering</li> <li>If products are used beyond the range of the recommended conditions, heat stresses may deform the products, and consequently degrade the reliability of the products.</li> <li>•NR30/40/50/60/80, NRV20/30, NRH24/30, NRS20/40/50/60/80 Type, NR10050 Type, NS101/125 Type Recommended reflow condition (Pb free solder)</li> <li>300</li> <li>5sec max</li> <li>•Peak:</li> <li>200</li> <li>150~180</li> <li>90±30sec</li> <li>30±10sec</li> <li>30°C min</li> <li>Heating Time [sec]</li> </ul>

5. Cleaning	
Precautions	<ul> <li>Cleaning conditions</li> <li>1. Washing by supersonic waves shall be avoided.</li> </ul>
Technical considerations	<ul> <li>Cleaning conditions</li> <li>1. If washed by supersonic waves, the products might be broken.</li> </ul>

6. Handling	
Precautions	<ul> <li>Handling <ol> <li>Keep the product away from all magnets and magnetic objects.</li> <li>Breakaway PC boards (splitting along perforations) <ol> <li>When splitting the PC board after mounting product, care should be taken not to give any stresses of deflection or twisting to the board.</li> <li>Board separation should not be done manually, but by using the appropriate devices.</li> <li>Mechanical considerations <ol> <li>Please do not give the product any excessive mechanical shocks.</li> <li>Please do not add any shock and power to a product in transportation.</li> </ol> </li> <li>Pick-up pressure <ol> <li>Please do not push to add any pressure to a winding part. Please do not give any shock and push into a ferrite core exposure part.</li> </ol> </li> <li>Packing <ol> <li>Please avoid accumulation of a packing box as much as possible.</li> </ol> </li> <li>Board mounting <ol> <li>There shall be no pattern or via between terminals at the bottom of product.</li> </ol> </li> </ol></li></ol></li></ul>
Technical considerations	<ul> <li>Handling <ol> <li>There is a case that a characteristic varies with magnetic influence.</li> <li>Breakaway PC boards (splitting along perforations) <ol> <li>The position of the product on PCBs shall be carefully considered to minimize the stress caused from splitting of the PCBs.</li> </ol> </li> <li>Mechanical considerations <ol> <li>There is a case to be damaged by a mechanical shock.</li> <li>There is a case to be broken by the handling in transportation.</li> <li>Pick-up pressure <ol> <li>Damage and a characteristic can vary with an excessive shock or stress.</li> </ol> </li> <li>Packing <ol> <li>If packing boxes are accumulated, that could cause a deformation on packing tapes or a damage on the products.</li> </ol> </li> <li>Board mounting <ol> <li>If there is pattern or via between terminals at the bottom of product, it may cause characteristics change.</li> </ol> </li> <li>If components which are located in peripheral of product make contact with surface (top, side) of product, it may cause damage or characteristics change.</li> </ol> </li> </ol></li></ul>

7. Storage conditions	
Precautions	<ul> <li>Storage         <ol> <li>To maintain the solderability of terminal electrodes and to keep the packing material in good condition, temperature and humidity in the storage area should be controlled.             <ul> <li>Recommended conditions</li></ul></li></ol></li></ul>
Technical considerations	<ul> <li>Storage</li> <li>1. Under a high temperature and humidity environment, problems such as reduced solderability caused by oxidation of terminal electrodes and deterioration of taping/packaging materials may take place.</li> </ul>



# **Mouser Electronics**

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MDMK4040T2R2MFV MDMK2020T2R2MMV MDMK4040T1R0MFV MDMK2020T3R3MMV MDMK2020T4R7MMV
MDMK4040T1R2MFV MDMK4040T1R5MFV MDMK3030T3R3MMV MDKK3030T2R2MMV MDKK2020T100MMV
MDMK3030T1R0MMV MDMK3030T4R7MMV MDMK3030TR30MMV MDMK3030T1R5MMV MDKK2020T2R2MMV
MDKK2020T1R0MMV MDWK4040T6R8MMV MDWK4040T1R0MMV MDMK4040T1R5MMV MDWK4040T100MMV
MDMK4040T1R0MMV MDMK4040TR68MMV MDWK4040TR68MMV MDWK4040TR56NMV MDWK4040T2R2MMV
MDMK4040T3R3MMV MDMK4040T4R7MMV MDMK4040T2R2MMV MDWK4040T3R3MMV MDWK4040T4R7MMV
MDMK4040T6R8MMV MDWK4040T1R5MMV MDMK4040T100MMV MDMK3030TR33MMV MDMK3030TR47MMV
MDKK2020T1R5MMV MDKK2020T3R3MMV MDKK2020T4R7MMV MDKK3030T4R7MMV MDKK3030T6R8MMV
MDKK3030TR47MMV MDMK3030T2R2MMV MDKK2020TR47MMV MDKK2020TR68MMV MDKK3030T100MMV
MDKK3030T1R0MMV MDKK3030T1R5MMV MDKK3030T3R3MMV